

JCO-1000-ORN-A

Lite-Range AI Computer NVIDIA Jetson Orin™ NX Super 8G/16G or Nano Super 8G/4G GPU with 32 Tensor Cores

Features

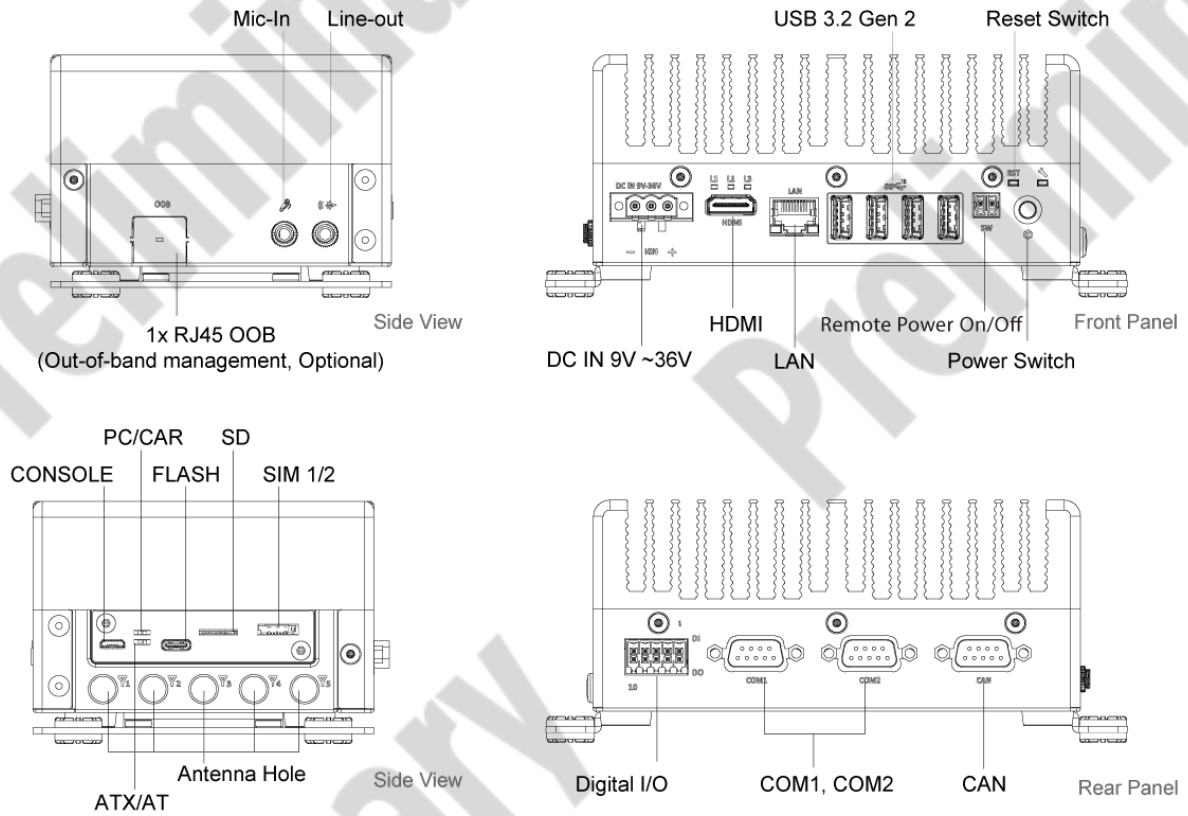
- NVIDIA® Jetson Orin™ NX Super 8GB/16GB or Nano Super 8GB/4GB GPU with 32 Tensor Cores
- 1x HDMI 2.0, 3840 x 2160 @ 60Hz
- 1x 2.5 GbE LAN
- 1x External Dual Nano SIM socket
- 1x M.2 (M Key, 2242/2280, PCIe 4, NVMe Storage) (128GB Default)
- 4x USB 3.2 Gen 2, 1x USB Type-C (For OS Flash)
- 4x DI + 4x DO with isolation
- 9 to 36VDC Wide Range Power Input Supporting AT/ATX Mode
- Wide Operating Temperature -20°C up to 60°C



Specifications

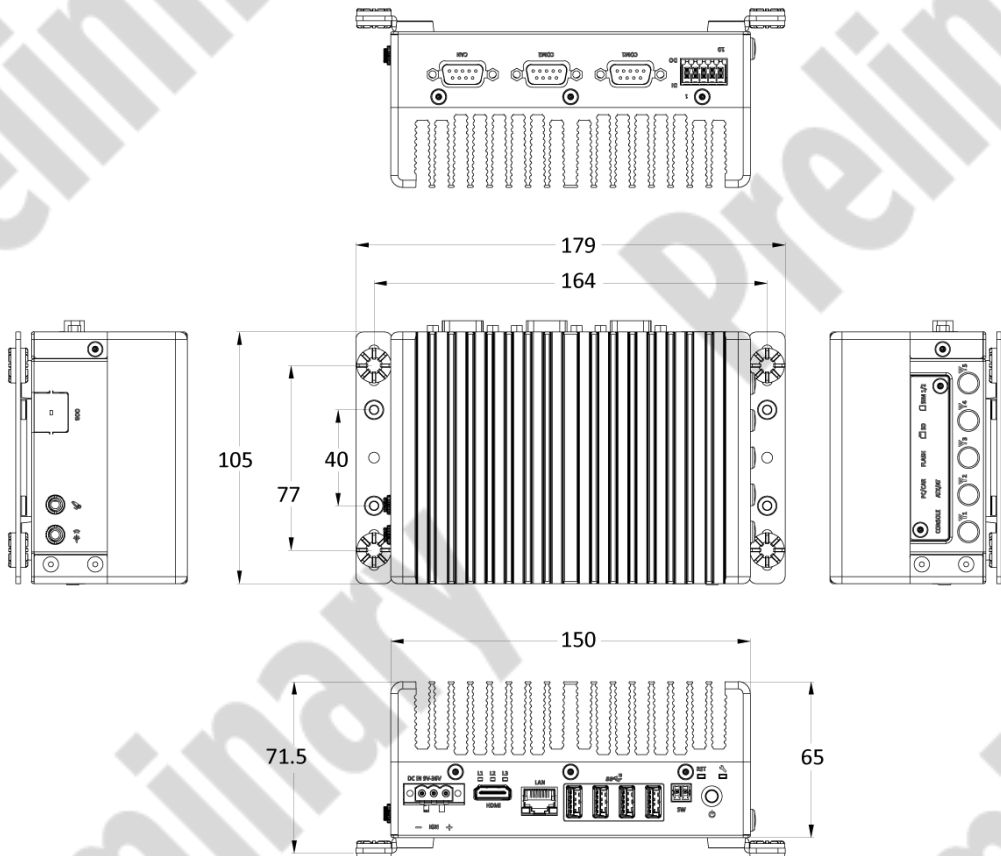
System		Environment	
Processor		Operating Temperature	
- NVIDIA® Jetson Orin™ NX Super/Nano Super GPU with 32 Tensor Cores		-20°C to 60°C (15W)	
• 16 GB: 1024-core NVIDIA Ampere architecture GPU (40W/157 TOPS)		-20°C to 55°C (25W)	
• 8 GB: 1024-core NVIDIA Ampere architecture GPU (40W/117 TOPS)		-20°C to 40°C (40W)	
• 8 GB: 1024-core NVIDIA Ampere architecture GPU (25W/67 TOPS)		Storage Temperature	
• 4 GB: 512-core NVIDIA Ampere architecture GPU (25W/34 TOPS)		-30°C to 85°C	
LAN Chipset	GbE1: RGMII	Relative Humidity	
Watchdog	Software Programmable Supports 1~255 sec. System Reset	10% to 95% (non-condensing)	
TPM	TPM 2.0	Certification	
		CE, FCC Class B, UL 62368-1, 3rd Ed., RoHS 3.0, REACH	
		Vibration	
		With SSD: 5 Grms (5 - 500 Hz, 0.5 hr/axis)	
		Shock	
		With SSD: 50G half-sin 11ms	
Display		Physical	
HDMI	1x HDMI 2.0, 3840 x 2160 @ 60Hz	Dimensions	
		150 (W) x 105 (D) x 65 (H) mm	
		Weights	
		1.1kg	
		Construction	
		Extruded Aluminum with Heavy Duty Metal	
		Mounting Options	
		Wall Mounting	
Storage			
M.2	1x M.2 (M Key, 2242/2280, PCIe x4, NVMe) (Default 128GB)		
SD	1x Micro 2.0 SD Slot		
SIM Socket	1x External Dual Nano SIM socket (Attached to M.2 B Key)		
Expansion			
M.2	1x M.2 (B Key, 2242/3042/3052, PCIe x1, USB 3.2 Gen1, Support 4G/5G Module)		
	1x M.2 (E Key, 2230, PCIe x1, USB 2.0, Support Wi-Fi/Bluetooth)		
I/O			
CAN	CAN 2.0 B		
COM	2x RS-232/422/485		
DIO	4 in / 4 out (Isolated)		
LAN	1x 2.5GbE RJ45		
OOB	1x RJ45 (Optional OOB Management Module, Occupied 1x COM & Micro USB Console Port)		
USB	4x USB 3.2 Gen 2 (10 Gbps)		
	1x USB Type-C (For OS Flash)		
	1x Micro USB (Console)		
LED	4x LED		
	LED 1 : System Status (Blue Color)		
	LED 2 : Programmable LED (Blue Color)		
	LED 3 : Programmable LED (Blue Color)		
	LED 4 : Programmable LED (Red Color)		
Others	5x WiFi Antenna Holes		
	1x Power Switch, 1x Reset Switch, 1x 2P Terminal Block for Remote SW		
	1x CMOS Battery Cable		
	1x 4-Pin FAN Connector		
	1x 1.5 Pitch 3-Pin Debug Port header for OOB		
	1x MIPI CSI-2 22-Pin Connectors		
Audio	1x Mic-in, 1x Line-out		
Operating System			
Linux	Linux Ubuntu 22.04 with JetPack 6.2		
Power			
Power Adapter	Optional AC/DC 12V/5A, 60W		
Power Mode	AT, ATX		
Power Supply Voltage	DC IN 9~36V		
Power Connector	3-pin Terminal Block		
Power Protection	OVP (Over Voltage Protection);		
	OCP (Over Current Protection)		
	Reverse Protection		

External I/O Mechanical Layout



Dimension

Unit: mm



Available Models

Model No.	Description
JCO-1000-ORN-A-NX16	Basic Fanless Edge AI Embedded Computer with NVIDIA® Jetson Orin™ NX Super 16G, 1x HDMI, 1x LAN, 4x USB, 1x CAN
JCO-1000-ORN-A-NX8	Basic Fanless Edge AI Embedded Computer with NVIDIA® Jetson Orin™ NX Super 8G, 1x HDMI, 1x LAN, 4x USB, 1x CAN
JCO-1000-ORN-A-NN8	Basic Fanless Edge AI Embedded Computer with NVIDIA® Jetson Orin™ Nano Super 8G, 1x HDMI, 1x LAN, 4x USB, 1x CAN
JCO-1000-ORN-A-NN4	Basic Fanless Edge AI Embedded Computer with NVIDIA® Jetson Orin™ Nano Super 4G, 1x HDMI, 1x LAN, 4x USB, 1x CAN

Optional Accessories

Model No.	Description
1-E09A06008	Adapter AC/DC 12V 5A 60W with 3pin Terminal Block Plug 5.0mm Pitch
1-TPCD00005	Power Cord, 3-pin US Type, 180cm
1-TPCD00002	Power Cord, European Type, 180cm
1-TPCD00001	Power Cord, 3-pin UK Type, 180cm

Packing List

1x JCO-1000-ORN-A Lite-Range AI Computer
1x Wall Mount Kit
1x Accessory Kit

Compliances and Standards

Shock	With SSD: 50G half-sin 11ms IEC60068-2-27:2008 Designed to comply with MIL-STD-810G Method 516.7 Procedure I
Vibration	With SSD: 5 Grms (5 - 500 Hz, 0.5 hr/axis) IEC60068-2-64:2008 Designed to comply with MIL-STD-810G Method 514.7 Procedure I
Operating Temperature	-20°C to 60°C (15W) -20°C to 55°C (25W) -20°C to 40°C (40W) IEC60068-2-1:2007 (Cold test procedure) IEC60068-2-2:2007 (Dry heat test procedure) IEC60068-2-3:2007 (Damp heat, steady state, test procedure) IEC60068-2-14:2009 (Wide temperature range thermal shock)"
EMC	• FCC Class B • CE • ICES-003 • UKCA • Industrial EMC Compliance - EN 61000-4-2: 2009 - EN IEC 61000-4-3: 2020 - EN 61000-4-4: 2012 - EN 61000-4-5: 2014 +A1: 2017 - EN 61000-4-6: 2014 "
Safety	• UL Safety: UL 62368-1, 3rd Ed., (cULus) • Test procedure: CB Scheme • Standard: IEC 62368-1:2018